Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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MOS FIELD EFFECT POWER TRANSISTORS



 μ PA1702

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is N-Channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

FEATURES

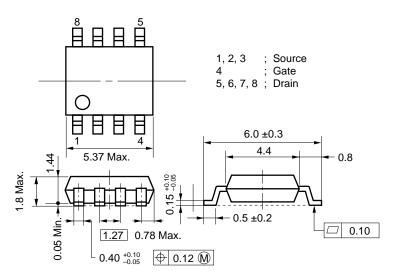
· Low On-Resistance.

 $R_{DS(on)1}$ = 15 m Ω Max. (V_{GS} = 10 V, I_D = 4.0 A) $R_{DS(on)2}$ = 25 m Ω Max. (V_{GS} = 4 V, I_D = 4.0 A)

- Low Ciss Ciss = 1300 pF Typ.
- · Built-in G-S Protection Diode
- Small and Surface Mount Package (Power SOP8)

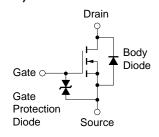
PACKAGE DIMENSIONS

(in: millimeter)



ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, all terminals are connected)

Drain to Source Voltage	VDSS	30	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	ID(DC)	±8.0	Α
Drain Current (pulse)*	ID(pulse)	±32	Α
Total Power Dissipation (T _A = 25 °C) **	Рт	2.0	W
Channel Temperature	T_ch	150	\mathbb{C}
Storage Temperature	T _{stg}	-55 to +150	$^{\circ}$



- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Mounted on ceramic substrate of 1200 mm $^2 \times 0.7$ mm

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device acutally used, an additional protection circuit is externally required if voltage exceeding the rated voltage may be applied to this device.

The information in this document is subject to change without notice.

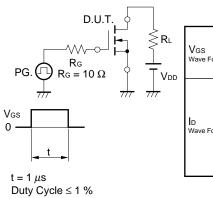


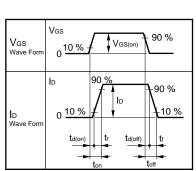


ELECTRICAL CHARACTERISTICS (TA = 25 °C, all terminals are connected)

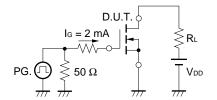
Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 4.0 A		11.5	15	mΩ
	RDS(on)2	Vgs = 4 V, ID = 4.0 A		18	25	mΩ
Gate to Source Cutoff Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.0	1.4	2.0	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 4.0 A	6.0	12		S
Drain Leakage Current	IDSS	V _{DS} = 30 V, V _{GS} = 0			10	μΑ
Gate to Source Leakage Current	Igss	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$			±10	μΑ
Input Capacitance	Ciss	V _{DS} = 10 V V _{GS} = 0 f = 1 MHz		1300		pF
Output Capacitance	Coss			840		pF
Reverse Transfer Capacitance	Crss			350		pF
Turn-On Delay Time	td(on)	$I_D = 4.0 \text{ A}$ $V_{GS(on)} = 10 \text{ V}$ $V_{DD} = 15 \text{ V}$ $R_G = 10 \Omega$		25		ns
Rise Time	tr			120		ns
Turn-off Delay Time	td(off)			125		ns
Fall Time	t f			90		ns
Total Gate Charge	Q _G	I _D = 8.0 A V _{DD} = 24 V V _{GS} = 10 V		44		nC
Gate to Source Charge	Qgs			3.0		nC
Gate to Drain Charge	Q _{GD}			15		nC
Body Diode Forward Voltage	V _F (S-D)	IF = 8.0 A, VGS = 0		0.8		V
Reverse Recovery Time	trr	IF = 8.0 A, VGS = 0		65		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		90		nC

Test Circuit 1 Switching Time

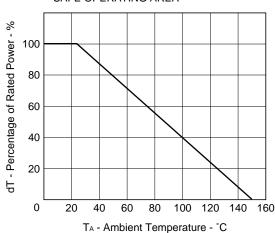




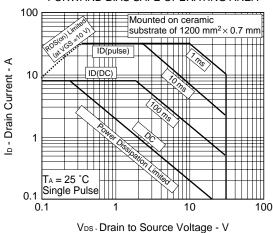
Test Circuit 2 Gate Charge



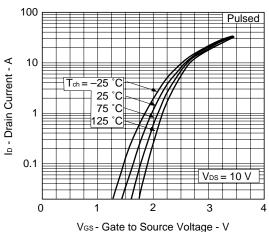
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



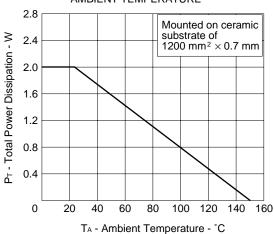
FORWARD BIAS SAFE OPERATING AREA



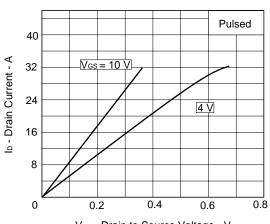
FORWARD TRANSFER CHARACTERISTICS



TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE

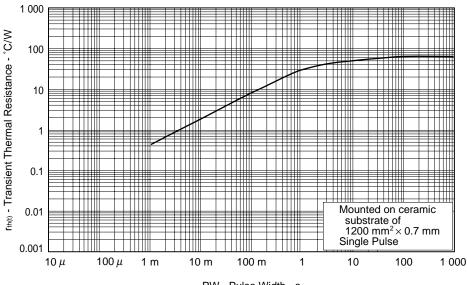


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



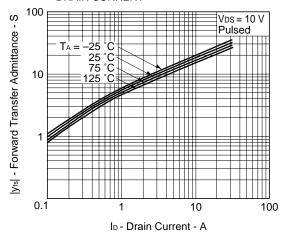
V_{DS} - Drain to Source Voltage - V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

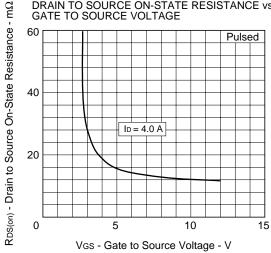


PW - Pulse Width - s

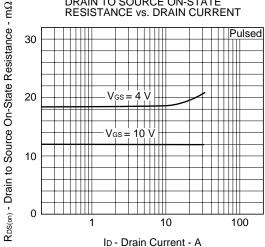
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



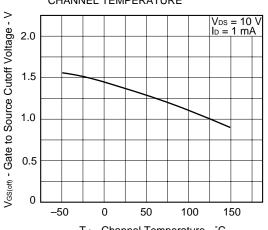
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



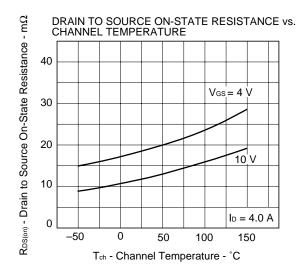
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

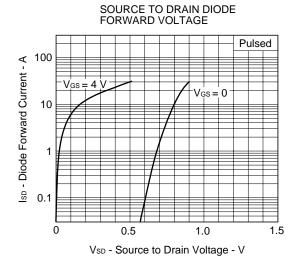


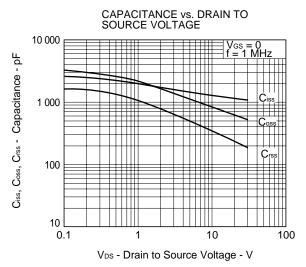
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

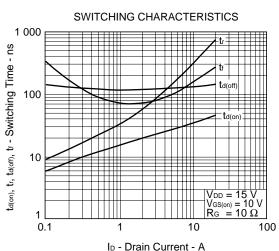


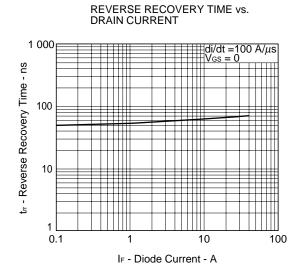
Tch - Channel Temperature - °C

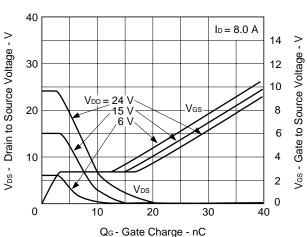












DYNAMIC INPUT/OUTPUT CHARACTERISTICS





REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system	TEI-1202
Quality grade on NEC semiconductor devices	IEI-1209
Semiconductor device mounting technology manual	C10535E
Semiconductor device package manual	C10943X
Guide to quality assurance for semiconductor devices	MEI-1202
Semiconductor selection guide	X10679E
Power MOS FET features and application switching power supply	TEA-1034
Application circuits using Power MOS FET	TEA-1035
Safe operating area of Power MOS FET	TEA-1037

[MEMO]



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Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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